

12-Output Clock Generator with Integrated 2.0 GHz VCO

Data Sheet AD9517-3

FEATURES

Low phase noise, phase-locked loop (PLL)
On-chip VCO tunes from 1.75 GHz to 2.25 GHz
External VCO/VCXO to 2.4 GHz optional
1 differential or 2 single-ended reference inputs
Reference monitoring capability
Automatic revertive and manual reference
switchover/holdover modes
Accepts LVPECL, LVDS, or CMOS references to 250 MHz
Programmable delays in path to PFD

Digital or analog lock detect, selectable 2 pairs of 1.6 GHz LVPECL outputs

Each output pair shares a 1-to-32 divider with coarse phase delay

Additive output jitter: 225 fs rms

Channel-to-channel skew paired outputs of <10 ps

2 pairs of 800 MHz LVDS clock outputs

Each output pair shares two cascaded 1-to-32 dividers with coarse phase delay

Additive output jitter: 275 fs rms

Fine delay adjust (Δt) on each LVDS output

Each LVDS output can be reconfigured as two 250 MHz

CMOS outputs

Automatic synchronization of all outputs on power-up Manual output synchronization available Available in a 48-lead LFCSP

APPLICATIONS

Low jitter, low phase noise clock distribution
10/40/100 Gb/sec networking line cards, including SONET,
Synchronous Ethernet, OTU2/3/4
Forward error correction (G.710)
Clocking high speed ADCs, DACs, DDSs, DDCs, DUCs, MxFEs
High performance wireless transceivers
ATE and high performance instrumentation

GENERAL DESCRIPTION

The AD9517-3¹ provides a multi-output clock distribution function with subpicosecond jitter performance, along with an on-chip PLL and VCO. The on-chip VCO tunes from 1.75 GHz to 2.25 GHz. Optionally, an external VCO/VCXO of up to 2.4 GHz can be used.

The AD9517-3 emphasizes low jitter and phase noise to maximize data converter performance, and it can benefit other applications with demanding phase noise and jitter requirements.

FUNCTIONAL BLOCK DIAGRAM

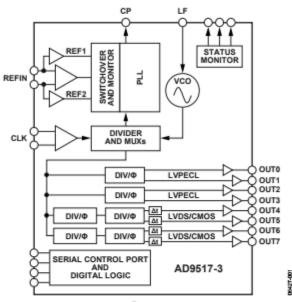


Figure 1.

The AD9517-3 features four LVPECL outputs (in two pairs) and four LVDS outputs (in two pairs). Each LVDS output can be reconfigured as two CMOS outputs. The LVPECL outputs operate to 1.6 GHz, the LVDS outputs operate to 800 MHz, and the CMOS outputs operate to 250 MHz.

For applications that require additional outputs, a crystal reference input, zero-delay, or EEPROM for automatic configuration at startup, the AD9520 and AD9522 are available. In addition, the AD9516 and AD9518 are similar to the AD9517 but have a different combination of outputs.

Each pair of outputs has dividers that allow both the divide ratio and coarse delay (or phase) to be set. The range of division for the LVPECL outputs is 1 to 32. The LVDS/CMOS outputs allow a range of divisions up to a maximum of 1024.

The AD9517-3 is available in a 48-lead LFCSP and can be operated from a single 3.3 V supply. An external VCO, which requires an extended voltage range, can be accommodated by connecting the charge pump supply (VCP) to 5 V. A separate LVPECL power supply can be from 2.5 V to 3.3 V (nominal).

The AD9517-3 is specified for operation over the industrial range of -40°C to +85°C.

¹ AD9517 is used throughout the data sheet to refer to all the members of the AD9517 family. However, when AD9517-3 is used, it refers to that specific member of the AD9517 family.

SPECIFICATIONS

Typical is given for $V_S = V_{S_LVPECL} = 3.3 \text{ V} \pm 5\%$; $V_S \leq V_{CP} \leq 5.25 \text{ V}$; $T_A = 25^{\circ}\text{C}$; RSET = 4.12 k Ω ; CPRSET = 5.1 k Ω , unless otherwise noted. Minimum and maximum values are given over full V_S and T_A (-40°C to +85°C) variation.

POWER SUPPLY REQUIREMENTS

Table 1.

Parameter	Min	Тур	Max	Unit	Test Conditions/Comments
Vs	3.135	3.3	3.465	٧	3.3 V ± 5%
Vs_LVPECL	2.375		Vs	V	Nominally 2.5 V to 3.3 V ± 5%
Vcp	Vs		5.25	V	Nominally 3.3 V to 5.0 V ± 5%
RSET Pin Resistor		4.12		kΩ	Sets internal biasing currents; connect to ground
CPRSET Pin Resistor	2.7	5.1	10	kΩ	Sets internal CP current range, nominally 4.8 mA (CP_lsb = 600 μA); actual current can be calculated by CP_lsb = 3.06/CPRSET; connect to ground
BYPASS Pin Capacitor		220		nF	Bypass for internal LDO regulator; necessary for LDO stability; connect to ground

PLL CHARACTERISTICS

Table 2.

Parameter	Min	Тур	Max	Unit	Test Conditions/Comments
VCO (ON-CHIP)					
Frequency Range	1750		2250	MHz	See Figure 15
VCO Gain (K _{vco})		50		MHz/V	See Figure 10
Tuning Voltage (V ₁)	0.5		Væ – 0.5	V	Vcr ≤ Vs when using internal VCO; outside of this range, the CP spurs may increase due to CP up/down mismatch
Frequency Pushing (Open Loop)		1		MHz/V	
Phase Noise at 100 kHz Offset		-108		dBc/Hz	f = 2000 MHz
Phase Noise at 1 MHz Offset		-126		dBc/Hz	f = 2000 MHz
REFERENCE INPUTS					
Differential Mode (REFIN, REFIN)					Differential mode (can accommodate single-ended input by ac grounding undriven input)
Input Frequency	0		250	MHz	Frequencies below about 1 MHz should be dc-coupled; be careful to match Vox (self-bias voltage)
Input Sensitivity		250		mV p-p	PLL figure of merit (FOM) increases with increasing slew rate (see Figure 14); the input sensitivity is sufficient for ac-coupled LVDS and LVPECL signals
Self-Bias Voltage, REFIN	1.35	1.60	1.75	V	Self-bias voltage of REFIN¹
Self-Bias Voltage, REFIN	1.30	1.50	1.60	V	Self-bias voltage of REFIN¹
Input Resistance, REFIN	4.0	4.8	5.9	kΩ	Self-biased ¹
Input Resistance, REFIN	4.4	5.3	6.4	kΩ	Self-biased ¹
Dual Single-Ended Mode (REF1, REF2)					Two single-ended CMOS-compatible inputs
Input Frequency (AC-Coupled)	20		250	MHz	Slew rate > 50 V/μs
Input Frequency (DC-Coupled)	0		250	MHz	Slew rate > 50 V/μs; CMOS levels
Input Sensitivity (AC-Coupled)		8.0		V p-p	Should not exceed V _s p-p
Input Logic High	2.0			V	
Input Logic Low			0.8	V	
Input Current	-100		+100	μА	
Pulse Width High/Low	1.8			ns	This value determines the allowable input duty cycle and is the amount of time that a square wave is high/low
Input Capacitance		2		pF	Each pin, REFIN/REFIN (REF1/REF2)
PHASE/FREQUENCY DETECTOR (PFD)					
PFD Input Frequency			100	MHz	Antibacklash pulse width = 1.3 ns, 2.9 ns
			45	MHz	Antibacklash pulse width = 6.0 ns
Antibacklash Pulse Width		1.3		ns	Register 0x017[1:0] = 01b
		2.9		ns	Register 0x017[1:0] = 00b; Register 0x017[1:0] = 11b
		6.0		ns	Register 0x017[1:0] = 10b

Parameter	Min	Тур	Max	Unit	Test Conditions/Comments
CHARGE PUMP (CP)					CPv is CP pin voltage; Vcp is charge pump power supply voltage
I _{CP} Sink/Source					Programmable
High Value		4.8		mA	With $CP_{RSET} = 5.1 \text{ k}\Omega$
Low Value		0.60		mA	
Absolute Accuracy		2.5		%	$CP_V = V_{CP}/2 V$
CPRSET Range		2.7/10		kΩ	
Ice High Impedance Mode Leakage		1		nA	
Sink-and-Source Current Matching		2		%	0.5 < CP _V < V _{CP} = 0.5 V
I _{CP} vs. CP _V		1.5		%	0.5 < CP _V < V _{CP} = 0.5 V
lc vs. Temperature		2		96	CPv = Vcp/2 V
PRESCALER (PART OF N DIVIDER)					See the VCXO/VCO Feedback Divider N—P, A, B, R section
Prescaler Input Frequency					
P=1 FD			300	MHz	
P = 2 FD			600	MHz	
P = 3 FD			900	MHz	
P = 2 DM (2/3)			200	MHz	
P = 4 DM (4/5)			1000	MHz	
P = 8 DM (8/9)			2400	MHz	
P = 16 DM (16/17)			3000	MHz	
P = 32 DM (32/33)			3000	MHz	
Prescaler Output Frequency			300	MHz	A, B counter input frequency (prescaler input frequency
					divided by P)
PLL DIVIDER DELAYS					Register 0x019: R, Bits[5:3]; N, Bits[2:0]; see Table 54
000		Off		ps	
001		330		ps	
010		440		ps	
011		550		ps	
100		660		ps	
101		770		ps	
110		880		ps	
111		990		ps	
NOISE CHARACTERISTICS					
In-Band Phase Noise of the Charge					The PLL in-band phase noise floor is estimated by measuring
Pump/Phase Frequency Detector					the in-band phase noise at the output of the VCO and
(In-Band Is Within the LBW of the PLL)		165		dDa/U=	subtracting 20 log(N) (where N is the value of the N divider)
At 500 kHz PFD Frequency At 1 MHz PFD Frequency		-165 -162		dBc/Hz dBc/Hz	
At 10 MHz PFD Frequency		-151 -143		dBc/Hz dBc/Hz	
At 50 MHz PFD Frequency		-143 -220		dBc/Hz	Perforance slow rate > 0.35 Wher FOM +10 leads No an approved
PLL Figure of Merit (FOM)		-220		dBC/HZ	Reference slew rate > 0.25 V/ns; FOM +10 log(f _{FD}) is an approxi- mation of the PFD/CP in-band phase noise (in the flat region)
					inside the PLL loop bandwidth; when running closed-loop, the
					phase noise, as observed at the VCO output, is increased by
					20 log(N)
DIL DICITAL LOCK DETECT WINDOWS	1			 	Cinnal available at ID CTATUS and DESALON also
PLL DIGITAL LOCK DETECT WINDOW ²					Signal available at LD, STATUS, and REFMON pins when selected by appropriate register settings
Required to Lock (Coincidence of Edges)					Selected by Register 0x017[1:0] and Register 0x018[4]
Low Range (ABP 1.3 ns, 2.9 ns)		3.5		ns	Register 0x017[1:0] = 00b, 01b, 11b; Register 0x018[4] = 1b
High Range (ABP 1.3 ns, 2.9 ns)		7.5		ns	Register 0x017[1:0] = 00b, 01b, 11b, Register 0x018[4] = 1b
High Range (ABP 6.0 ns)		3.5		ns	Register 0x017[1:0] = 00b, 01b, 11b, Register 0x018[4] = 0b
To Unlock After Lock (Hysteresis) ²		3.3		3	negister oxor/[1.0] = 100/negister oxoro[4] = 00
		7		ns	Register 0x017[1:0] = 00b, 01b, 11b; Register 0x018[4] = 1b
Low Range (ARP 13 ns 20 ns)					
Low Range (ABP 1.3 ns, 2.9 ns) High Range (ABP 1.3 ns, 2.9 ns)		15		ns	Register 0x017[1:0] = 00b, 01b, 11b; Register 0x018[4] = 0b

¹ REFIN and REFIN self-bias points are offset slightly to avoid chatter on an open input condition.

² For reliable operation of the digital lock detect, the period of the PFD frequency must be greater than the unlock-after-lock time.

CLOCK INPUTS

Table 3.

Parameter	Min	Тур	Max	Unit	Test Conditions/Comments
CLOCK INPUTS (CLK, CLK)					Differential input
Input Frequency	01		2.4	GHz	High frequency distribution (VCO divider)
	01		1.6	GHz	Distribution only (VCO divider bypassed)
Input Sensitivity, Differential		150		mV p-p	Measured at 2.4 GHz; jitter performance is improved with slew rates > 1 V/ns
Input Level, Differential			2	V p-p	Larger voltage swings may turn on the protection diodes and may degrade jitter performance
Input Common-Mode Voltage, V _{CM}	1.3	1.57	1.8	V	Self-biased; enables ac coupling
Input Common-Mode Range, VCMR	1.3		1.8	V	With 200 mV p-p signal applied; dc-coupled
Input Sensitivity, Single-Ended		150		mV p-p	CLK ac-coupled; CLK ac-bypassed to RF ground
Input Resistance	3.9	4.7	5.7	kΩ	Self-biased
Input Capacitance		2		pF	

¹ Below about 1 MHz, the input should be dc-coupled. Care should be taken to match V_{OM}.

CLOCK OUTPUTS

Table 4.

Parameter	Min	Тур	Max	Unit	Test Conditions/Comments
LVPECL CLOCK OUTPUTS					Termination = 50 Ω to Vs – 2 V
OUT0, OUT1, OUT2, OUT3					Differential (OUT, OUT)
Output Frequency, Maximum	2950			MHz	Using direct to output; see Figure 25 for peak-to-peak differential amplitude
Output High Voltage (V _{OH})	V _{S_LVPECL} — 1.12	V _{S_LWPECL} = 0.98	V _{S_LVPECL} — 0.84	V	
Output Low Voltage (V ₀)	V _{S_LVPECL} — 2.03	V _{S_LWPECL} — 1.77	V _{S_LVPECL} — 1.49	V	
Output Differential Voltage (V ₀₀)	550	790	980	mV	This is V _{OH} – V _{OL} for each leg of a differential pair for default amplitude setting with driver not toggling; the peak-to-peak amplitude measured using a differential probe across the differential pair with the driver toggling is roughly 2× these values (see Figure 25 for variation over frequency)
LVDS CLOCK OUTPUTS					Differential termination 100 Ω at 3.5 mA
OUT4, OUT5, OUT6, OUT7					Differential (OUT, OUT)
Output Frequency			800	MHz	The AD9517 outputs toggle at higher frequencies, bu the output amplitude may not meet the Voo specification; see Figure 26
Output Differential Voltage (Voo)	247	360	454	mV	V _{OH} − V _{OL} measurement across a differential pair at the default amplitude setting with output driver not toggling; see Figure 26 for variation over frequency
Delta V _{ob}			25	mV	This is the absolute value of the difference between Vop when the normal output is high vs. when the complementary output is high
Output Offset Voltage (Vos)	1.125	1.24	1.375	V	(VoH + Vox)/2 across a differential pair
Delta Vos			25	mV	This is the absolute value of the difference between Vos when the normal output is high vs. when the complementary output is high
Short-Circuit Current (IsA, IsB)		14	24	mA	Output shorted to GND

Parameter	Min	Тур	Max	Unit	Test Conditions/Comments
CMOS CLOCK OUTPUTS					
OUT4A, OUT4B, OUT5A, OUT5B, OUT6A, OUT6B, OUT7A, OUT7B					Single-ended; termination = 10 pF
Output Frequency			250	MHz	See Figure 27
Output Voltage					
High (V _{он})	$V_s - 0.1$			V	At 1 mA load
Low (Vo.)			0.1	V	At 1 mA load
Source Current					Exceeding these values can result in damage to the part
Static			20	mA	
Dynamic			16	mA	
Sink Current					Exceeding these values can result in damage to the part
Static			8	mA	
Dynamic			16	mA	

TIMING CHARACTERISTICS

Table 5.

Parameter	Min	Тур	Max	Unit	Test Conditions/Comments
LVPECL					Termination = 50Ω to $V_s - 2 V$; level = 810 mV
Output Rise Time, tre		70	180	ps	20% to 80%, measured differentially
Output Fall Time, t _{FP}		70	180	ps	80% to 20%, measured differentially
PROPAGATION DELAY, t _{PECL} , CLK-TO-LVPECL OUTPUT					
High Frequency Clock Distribution Configuration	835	995	1180	ps	See Figure 43
Clock Distribution Configuration	773	933	1090	ps	See Figure 45
Variation with Temperature		0.8		ps/°C	
OUTPUT SKEW, LVPECL OUTPUTS ¹					
LVPECL Outputs That Share the Same Divider		5	15	ps	
LVPECL Outputs on Different Dividers		13	40	ps	
All LVPECL Outputs Across Multiple Parts			220	ps	
LVDS					Termination = 100 Ω differential; 3.5 mA
Output Rise Time, tru		170	350	ps	20% to 80%, measured differentially ²
Output Fall Time, t _{FL}		160	350	ps	20% to 80%, measured differentially ²
PROPAGATION DELAY, t _{LVDS} , CLK-TO-LVDS OUTPUT				<u> </u>	Delay off on all outputs
For All Divide Values	1.4	1.8	2.1	ns	
Variation with Temperature		1.25		ps/°C	
OUTPUT SKEW, LVDS OUTPUTS ¹				,	Delay off on all outputs
LVDS Outputs That Share the Same Divider		6	62	ps	Sensy on on an outputs
LVDS Outputs on Different Dividers		25	150	ps	
All LVDS Outputs Across Multiple Parts			430	ps	
CMOS				P-2	Termination = open
Output Rise Time, tac		495	1000	ps	20% to 80%; CLOAD = 10 pF
Output Fall Time, t _{FC}		475	985	ps	80% to 20%; C _{LOAD} = 10 pF
PROPAGATION DELAY, t _{CMOS} , CLK-TO-CMOS OUTPUT				,	Fine delay off
For All Divide Values	1.6	2.1	2.6	ns	
Variation with Temperature		2.6		ps/°C	
OUTPUT SKEW, CMOS OUTPUTS¹				p	Fine delay off
CMOS Outputs That Share the Same Divider		4	66	ps	
All CMOS Outputs on Different Dividers		28	180	ps	
All CMOS Outputs Across Multiple Parts			675	ps	
				P	
DELAY ADJUST ³	 				LVDS and CMOS
Shortest Delay Range ⁴					Register 0x0A1 (0x0A4, 0x0A7, 0x0AA), Bits[5:0] = 101111b
Zero Scale	50	315	680	ps	Register 0x0A2 (0x0A5, 0x0A8, 0x0AB), Bits[5:0] = 000000b
Full Scale	540	880	1180		Register 0x0A2 (0x0A5, 0x0A8, 0x0AB), Bits[5:0] = 000000B
Longest Delay Range ⁴	340	000	1100	ps	Register 0x0A1 (0x0A4, 0x0A7, 0x0AA), Bits[5:0] = 000000b
Zero Scale	200	570	950	ps	Register 0x0A1 (0x0A4, 0x0A7, 0x0AA), Bis[5:0] = 0000000 Register 0x0A2 (0x0A5, 0x0A8, 0x0AB), Bits[5:0] = 0000000b
Quarter Scale	1.72	2.31	2.89	ns	Register 0x0A2 (0x0A5, 0x0A6, 0x0AB), Bits[5:0] = 000000B
Full Scale	5.7	8.0	10.1	ns	Register 0x0A2 (0x0A5, 0x0A8, 0x0AB), Bits[5:0] = 001100B
	5.7	0.0	10.1	113	negister oxonz (oxons, oxons, oxons), bits[3.0] = 1011110
Delay Variation with Temperature					
Short Delay Range ⁵		0.22		ns/90	
Zero Scale		0.23		ps/°C	
Full Scale		- 0.02		ps/°C	
Long Delay Range ⁵		0.2		ns/90	
Zero Scale		0.3		ps/°C	
Full Scale		0.24		ps/°C	

¹This is the difference between any two similar delay paths while operating at the same voltage and temperature.

³ Corresponding CMOS drivers set to A for noninverting and B for inverting.

³ The maximum delay that can be used is a little less than one-half the period of the clock. A longer delay disables the output.

⁴ Incremental delay; does not include propagation delay.

⁵ All delays between zero scale and full scale can be estimated by linear interpolation.

CLOCK OUTPUT ADDITIVE PHASE NOISE (DISTRIBUTION ONLY; VCO DIVIDER NOT USED)

Table 6.

Parameter	Min Typ	Max	Unit	Test Conditions/Comments
CLK-TO-LVPECL ADDITIVE PHASE NOISE				Distribution section only; does not include PLL and VCO
CLK = 1 GHz, Output = 1 GHz				Input slew rate > 1 V/ns
Divider = 1				
At 10 Hz Offset	-109		dBc/Hz	
At 100 Hz Offset	-118		dBc/Hz	
At 1 kHz Offset	-130		dBc/Hz	
At 10 kHz Offset	-139		dBc/Hz	
At 100 kHz Offset	-144		dBc/Hz	
At 1 MHz Offset	-146		dBc/Hz	
At 10 MHz Offset	-147		dBc/Hz	
At 100 MHz Offset	-149		dBc/Hz	
CLK = 1 GHz, Output = 200 MHz				Input slew rate > 1 V/ns
Divider = 5				
At 10 Hz Offset	-120		dBc/Hz	
At 100 Hz Offset	-126		dBc/Hz	
At 1 kHz Offset	-139		dBc/Hz	
At 10 kHz Offset	-150		dBc/Hz	
At 100 kHz Offset	-155		dBc/Hz	
At 1 MHz Offset	-157		dBc/Hz	
>10 MHz Offset	-157		dBc/Hz	
				1
CLK-TO-LVDS ADDITIVE PHASE NOISE				Distribution section only; does not include PLL and VCO
CLK = 1.6 GHz, Output = 800 MHz				Input slew rate > 1 V/ns
Divider = 2				
At 10 Hz Offset	-103		dBc/Hz	
At 100 Hz Offset	-110		dBc/Hz	
At 1 kHz Offset	-120		dBc/Hz	
At 10 kHz Offset	-127		dBc/Hz	
At 100 kHz Offset	-133		dBc/Hz	
At 1 MHz Offset	-138		dBc/Hz	
At 10 MHz Offset	-147		dBc/Hz	
At 100 MHz Offset	-149		dBc/Hz	
CLK = 1.6 GHz, Output = 400 MHz				Input slew rate > 1 V/ns
Divider = 4				
At 10 Hz Offset	-114		dBc/Hz	
At 100 Hz Offset	-122		dBc/Hz	
At 1 kHz Offset	-132		dBc/Hz	
At 10 kHz Offset	-140		dBc/Hz	
At 100 kHz Offset	-146		dBc/Hz	
At 1 MHz Offset	-150		dBc/Hz	
>10 MHz Offset	-155		dBc/Hz	
CLK-TO-CMOS ADDITIVE PHASE NOISE				Distribution section only; does not include PLL and VCO
CLK = 1 GHz, Output = 250 MHz				Input slew rate > 1 V/ns
Divider = 4				
At 10 Hz Offset	-110		dBc/Hz	
At 100 Hz Offset	-120		dBc/Hz	
At 1 kHz Offset	-127		dBc/Hz	
At 10 kHz Offset	-136		dBc/Hz	
At 100 kHz Offset	-144		dBc/Hz	
At 1 MHz Offset	-147		dBc/Hz	
>10 MHz Offset	-154		dBc/Hz	

CLOCK OUTPUT ABSOLUTE TIME JITTER (CLOCK GENERATION USING INTERNAL VCO)

Table 8.

Parameter	Min	Тур	Max	Unit	Test Conditions/Comments
LVPECL OUTPUT ABSOLUTE TIME JITTER					Application example based on a typical setup where the reference source is clean, so a wider PLL loop bandwidth is used; reference = 15.36 MHz; R = 1
VCO = 1.97 GHz; LVPECL = 245.76 MHz; PLL LBW = 143 kHz		129		fs rms	Integration BW = 200 kHz to 10 MHz
		303		fs rms	Integration BW = 12 kHz to 20 MHz
VCO = 1.97 GHz; LVPECL = 122.88 MHz; PLL LBW = 143 kHz		135		fs rms	Integration BW = 200 kHz to 10 MHz
		302		fs rms	Integration BW = 12 kHz to 20 MHz
VCO = 1.97 GHz; LVPECL = 61.44 MHz; PLL LBW = 143 kHz		179		fs rms	Integration BW = 200 kHz to 10 MHz
		343		fs rms	Integration BW = 12 kHz to 20 MHz

CLOCK OUTPUT ABSOLUTE TIME JITTER (CLOCK CLEANUP USING INTERNAL VCO)

Table 9.

Parameter	Min	Тур	Max	Unit	Test Conditions/Comments
LVPECL OUTPUT ABSOLUTE TIME JITTER					Application example based on a typical setup where the reference source is jittery, so a narrower PLL loop bandwidth is used; reference = 10.0 MHz; R = 20
VCO = 1.87 GHz; LVPECL = 622.08 MHz; PLL LBW = 125 Hz		400		fs rms	Integration BW = 12 kHz to 20 MHz
VCO = 1.87 GHz; LVPECL = 155.52 MHz; PLL LBW = 125 Hz		390		fs rms	Integration BW = 12 kHz to 20 MHz
VCO = 1.97 GHz; LVPECL = 122.88 MHz; PLL LBW = 125 Hz		485		fs rms	Integration BW = 12 kHz to 20 MHz

CLOCK OUTPUT ABSOLUTE TIME JITTER (CLOCK GENERATION USING EXTERNAL VCXO)

Table 10.

Parameter	Min	Тур	Max	Unit	Test Conditions/Comments
LVPECL OUTPUT ABSOLUTE TIME JITTER					Application example based on a typical setup using an external 245.76 MHz VCXO (Toyocom TCO-2112); reference = 15.36 MHz; R = 1
LVPECL = 245.76 MHz; PLL LBW = 125 Hz		54		fs rms	Integration BW = 200 kHz to 5 MHz
		77		fs rms	Integration BW = 200 kHz to 10 MHz
		109		fs rms	Integration BW = 12 kHz to 20 MHz
LVPECL = 122.88 MHz; PLL LBW = 125 Hz		79		fs rms	Integration BW = 200 kHz to 5 MHz
		114		fs rms	Integration BW = 200 kHz to 10 MHz
		163		fs rms	Integration BW = 12 kHz to 20 MHz
LVPECL = 61.44 MHz; PLL LBW = 125 Hz		124		fs rms	Integration BW = 200 kHz to 5 MHz
		176		fs rms	Integration BW = 200 kHz to 10 MHz
		259		fs rms	Integration BW = 12 kHz to 20 MHz

CLOCK OUTPUT ADDITIVE TIME JITTER (VCO DIVIDER NOT USED)

Table 11.

Parameter	Min	Тур	Max	Unit	Test Conditions/Comments
LVPECL OUTPUT ADDITIVE TIME JITTER					Distribution section only; does not include PLL and VCO; uses rising edge of clock signal
CLK = 622.08 MHz; LVPECL = 622.08 MHz; Divider = 1		40		fs rms	BW = 12 kHz to 20 MHz
CLK = 622.08 MHz; LVPECL = 155.52 MHz; Divider = 4		80		fs rms	BW = 12 kHz to 20 MHz
CLK = 1.6 GHz; LVPECL = 100 MHz; Divider = 16		215		fs rms	Calculated from SNR of ADC method; DCC not used for even divides
CLK = 500 MHz; LVPECL = 100 MHz; Divider = 5		245		fs rms	Calculated from SNR of ADC method; DCC on
LVDS OUTPUT ADDITIVE TIME JITTER					Distribution section only; does not include PLL and VCO; uses rising edge of clock signal
CLK = 1.6 GHz; LVDS = 800 MHz; Divider = 2; VCO Divider Not Used		85		fs rms	BW = 12 kHz to 20 MHz
CLK = 1 GHz; LVDS = 200 MHz; Divider = 5		113		fs rms	BW = 12 kHz to 20 MHz
CLK = 1.6 GHz; LVDS = 100 MHz; Divider = 16		280		fs rms	Calculated from SNR of ADC method; DCC not used for even divides
CMOS OUTPUT ADDITIVE TIME JITTER					Distribution section only; does not include PLL and VCO; uses rising edge of clock signal
CLK = 1.6 GHz; CMOS = 100 MHz; Divider = 16		365		fs rms	Calculated from SNR of ADC method; DCC not used for even divides

CLOCK OUTPUT ADDITIVE TIME JITTER (VCO DIVIDER USED)

Table 12.

14010 121					
Parameter	Min	Тур	Max	Unit	Test Conditions/Comments
LVPECL OUTPUT ADDITIVE TIME JITTER					Distribution section only; does not include PLL and VCO; uses rising edge of clock signal
CLK = 2.4 GHz; VCO DIV = 2; LVPECL = 100 MHz; Divider = 12; Duty-Cycle Correction = Off		210		fs rms	Calculated from SNR of ADC method
LVDS OUTPUT ADDITIVE TIME JITTER					Distribution section only; does not include PLL and VCO; uses rising edge of clock signal
CLK = 2.4 GHz; VCO DIV = 2; LVDS = 100 MHz; Divider = 12; Duty-Cycle Correction = Off		285		fs rms	Calculated from SNR of ADC method
CMOS OUTPUT ADDITIVE TIME JITTER					Distribution section only; does not include PLL and VCO; uses rising edge of clock signal
CLK = 2.4 GHz; VCO DIV = 2; CMOS = 100 MHz; Divider = 12; Duty-Cycle Correction = Off		350		fs rms	Calculated from SNR of ADC method

DELAY BLOCK ADDITIVE TIME JITTER

Table 13.

Parameter	Min	Тур	Max	Unit	Test Conditions/Comments
DELAY BLOCK ADDITIVE TIME JITTER ¹					Incremental additive jitter
100 MHz Output					
Delay (1600 μA, 0x1C) Fine Adj. 000000b		0.54		ps rms	
Delay (1600 μA, 0x1C) Fine Adj. 101111b		0.60		ps rms	
Delay (800 μA, 0x1C) Fine Adj. 000000b		0.65		ps rms	
Delay (800 μA, 0x1C) Fine Adj. 101111b		0.85		ps rms	
Delay (800 μA, 0x4C) Fine Adj. 000000b		0.79		ps rms	
Delay (800 μA, 0x4C) Fine Adj. 101111b		1.2		ps rms	
Delay (400 μA, 0x4C) Fine Adj. 000000b		1.2		ps rms	
Delay (400 µA, 0x4C) Fine Adj. 101111b		2.0		ps rms	
Delay (200 µA, 0x1C) Fine Adj. 000000b		1.3		ps rms	
Delay (200 μA, 0x1C) Fine Adj. 101111b		2.5		ps rms	
Delay (200 μA, 0x4C) Fine Adj. 000000b		1.9		ps rms	
Delay (200 μA, 0x4C) Fine Adj. 101111b		3.8		ps rms	

¹ This value is incremental. That is, it is in addition to the jitter of the LVDS or CMOS output without the delay. To estimate the total jitter, the LVDS or CMOS output jitter should be added to this value using the root sum of the squares (RSS) method.

SERIAL CONTROL PORT

Table 14.

Parameter	Min	Тур	Max	Unit	Test Conditions/Comments
CS (INPUT)					CS has an internal 30 kΩ pull-up resistor
Input Logic 1 Voltage	2.0			V	
Input Logic 0 Voltage			0.8	V	
Input Logic 1 Current			3	μA	
Input Logic 0 Current		110		μA	
Input Capacitance		2		pF	
SCLK (INPUT)					SCLK has an internal 30 kΩ pull-down resistor
Input Logic 1 Voltage	2.0			V	
Input Logic 0 Voltage			0.8	V	
Input Logic 1 Current		110		μΑ	
Input Logic 0 Current			1	μΑ	
Input Capacitance		2		pF	
SDIO (WHEN INPUT)					
Input Logic 1 Voltage	2.0			V	
Input Logic 0 Voltage			0.8	V	
Input Logic 1 Current		10		nA	
Input Logic 0 Current		20		nA	
Input Capacitance		2		pF	
SDIO, SDO (OUTPUTS)					
Output Logic 1 Voltage	2.7			V	
Output Logic 0 Voltage			0.4	V	
TIMING					
Clock Rate (SCLK, 1/tsclk)			25	MHz	
Pulse Width High, t _{HIGH}	16			ns	
Pulse Width Low, t _{LOW}	16			ns	
SDIO to SCLK Setup, t _{DS}	2			ns	
SCLK to SDIO Hold, ton	1.1			ns	
SCLK to Valid SDIO and SDO, tov			8	ns	
CS to SCLK Setup and Hold, ts, th	2			ns	
CS Minimum Pulse Width High, tewn	3			ns	

\overline{PD} , \overline{SYNC} , AND \overline{RESET} PINS

Table 15.

Parameter	Min	Тур	Max	Unit	Test Conditions/Comments
INPUT CHARACTERISTICS					These pins each have a 30 $k\Omega$ internal pull-up resistor
Logic 1 Voltage	2.0			V	
Logic 0 Voltage			8.0	V	
Logic 1 Current			1	μA	
Logic 0 Current		110		μА	
Capacitance		2		pF	
RESET TIMING					
Pulse Width Low	50			ns	
SYNC TIMING					
Pulse Width Low	1.5			High speed clock cycles	High speed clock is CLK input signal

LD, STATUS, AND REFMON PINS

Table 16.

Parameter	Min	Тур	Max	Unit	Test Conditions/Comments
OUTPUT CHARACTERISTICS					When selected as a digital output (CMOS); there are other modes in which these pins are not CMOS digital outputs; see Table 54, Register 0x017, Register 0x01A, and Register 0x01B
Output Voltage High (VoH)	2.7			V	
Output Voltage Low (Vol)			0.4	V	
MAXIMUM TOGGLE RATE		100		MHz	Applies when mux is set to any divider or counter output, or PFD up/down pulse; also applies in analog lock detect mode; usually debug mode only; beware that spurs may couple to output when any of these pins are toggling
ANALOG LOCK DETECT					
Capacitance		3		pF	On-chip capacitance; used to calculate RC time constant for analog lock detect readback; use a pull-up resistor
REF1, REF2, AND VCO FREQUENCY STATUS MONITOR					
Normal Range	1.02			MHz	Frequency above which the monitor always indicates the presence of the reference
Extended Range (REF1 and REF2 Only)	8			kHz	Frequency above which the monitor always indicates the presence of the reference
LD PIN COMPARATOR					
Trip Point		1.6		V	
Hysteresis		260		mV	

TIMING DIAGRAMS

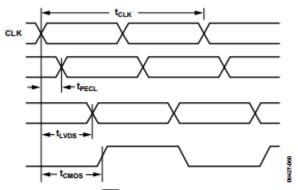


Figure 2. CLK/CLK to Clock Output Timing, DIV = 1

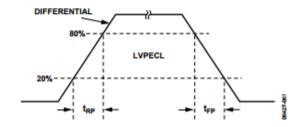


Figure 3. LVPECL Timing, Differential

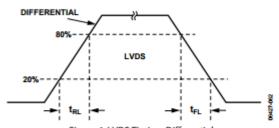


Figure 4. LVDS Timing, Differential

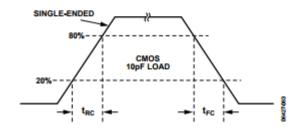


Figure 5. CMOS Timing, Single-Ended, 10 pF Load

POWER DISSIPATION

Table 17.

Parameter	Min	Тур	Max	Unit	Test Conditions/Comments
POWER DISSIPATION, CHIP					
Power-On Default		1.0	1.2	w	No clock; no programming; default register values; does not include power dissipated in external resistors
Full Operation; CMOS Outputs at 225 MHz		1.4	2.0	W	PLL on; internal VCO = 2250 MHz; VCO divider = 2; all channel dividers on; six LVPECL outputs at 562.5 MHz; eight CMOS outputs (10 pF load) at 225 MHz; all fine delay on, maximum current; does not include power dissipated in external resistors
Full Operation; LVDS Outputs at 225 MHz		1.4	2.1	W	PLL on; internal VCO = 2250 MHz, VCO divider = 2; all channel dividers on; six LVPECL outputs at 562.5 MHz; four LVDS outputs at 225 MHz; all fine delay on, maximum current; does not include power dissipated in external resistors
PD Power-Down		75	185	mW	PD pin pulled low; does not include power dissipated in terminations
PD Power-Down, Maximum Sleep		31		mW	PD pin pulled low; PLL power-down, Register 0x010[1:0] = 01b; SYNC power-down, Register 0x230[2] = 1b; REF for distribution power-down, Register 0x230[1] = 1b
V _{CP} Supply		4	4.8	mW	PLL operating; typical closed-loop configuration
POWER DELTAS, INDIVIDUAL FUNCTIONS					Power delta when a function is enabled/disabled
VCO Divider		30		mW	VCO divider bypassed
REFIN (Differential)		20		mW	All references off to differential reference enabled
REF1, REF2 (Single-Ended)		4		mW	All references off to REF1 or REF2 enabled; differential reference not enabled
VCO		70		mW	CLK input selected to VCO selected
PLL		75		mW	PLL off to PLL on, normal operation; no reference enabled
Channel Divider		30		mW	Divider bypassed to divide-by-2 to divide-by-32
LVPECL Channel (Divider Plus Output Driver)		160		mW	No LVPECL output on to one LVPECL output on, independent of frequency
LVPECL Driver		90		mW	Second LVPECL output turned on, same channel
LVDS Channel (Divider Plus Output Driver)		120		mW	No LVDS output on to one LVDS output on; see Figure 8 for dependence on output frequency
LVDS Driver		50		mW	Second LVDS output turned on, same channel
CMOS Channel (Divider Plus Output Driver)		100		mW	Static; no CMOS output on to one CMOS output on; see Figure 9 for variation over output frequency
CMOS Driver (Second in Pair)		0		mW	Static; second CMOS output, same pair, turned on
CMOS Driver (First in Second Pair)		30		mW	Static; first output, second pair, turned on
Fine Delay Block		50		mW	Delay block off to delay block enabled; maximum current setting

ABSOLUTE MAXIMUM RATINGS

Table 18.

14016 101									
Parameter	Rating								
VS, VS_LVPECL to GND	-0.3 V to +3.6 V								
VCP to GND	-0.3 V to +5.8 V								
REFIN, REFIN to GND	-0.3 V to V _s + 0.3 V								
REFIN to REFIN	-3.3 V to +3.3 V								
RSET to GND	$-0.3 \text{ V to V}_{\text{S}} + 0.3 \text{ V}$								
CPRSET to GND	-0.3 V to Vs + 0.3 V								
CLK, CLK to GND	-0.3 V to Vs + 0.3 V								
CLK to CLK	-1.2 V to +1.2 V								
SCLK, SDIO, SDO, CS to GND	$-0.3 \text{ V to V}_{\text{S}} + 0.3 \text{ V}$								
OUT0, OUT0, OUT1, OUT1, OUT2, OUT2,	$-0.3 \text{ V to V}_{\text{S}} + 0.3 \text{ V}$								
OUT3, OUT3, OUT4, OUT4, OUT5, OUT5,									
OUT6, OUT6, OUT7, OUT7 to GND									
SYNC to GND	-0.3 V to Vs + 0.3 V								
REFMON, STATUS, LD to GND	-0.3 V to V _s + 0.3 V								
Junction Temperature ¹	150°C								
Storage Temperature Range	-65°C to +150°C								
Lead Temperature (10 sec)	300°C								

¹ See Table 19 for θ_M.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL RESISTANCE

Table 19.

Package Type ¹	θ _{JA}	Unit
48-Lead LFCSP	24.7	°C/W

¹ Thermal impedance measurements were taken on a 4-layer board in still air in accordance with EIA/JESD51-2.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.